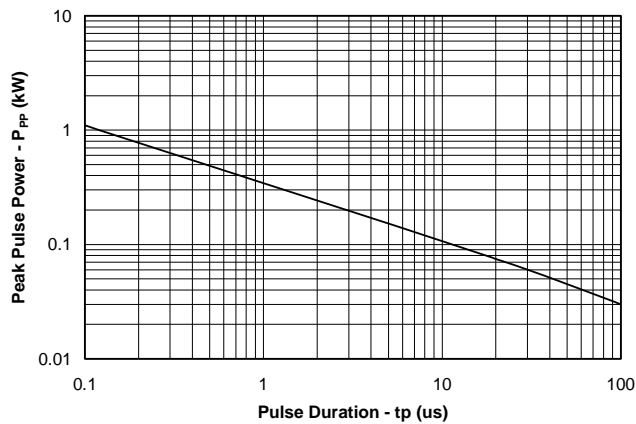
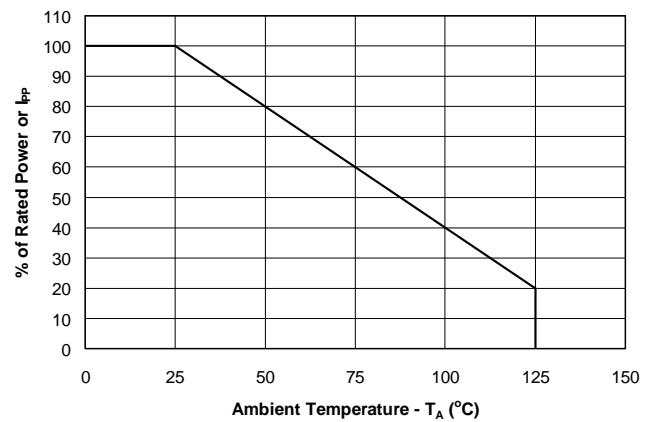
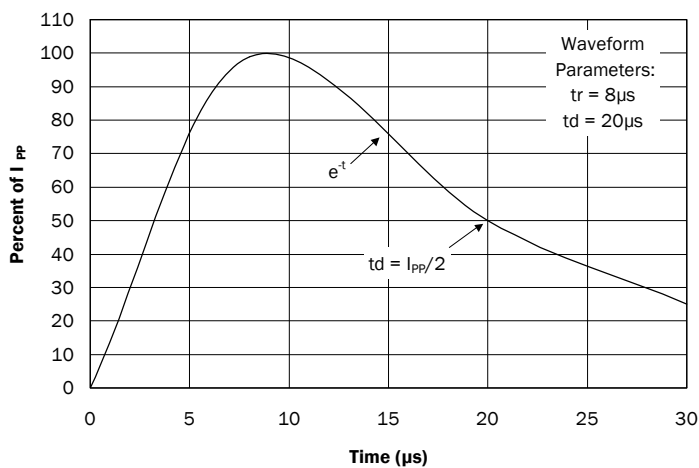
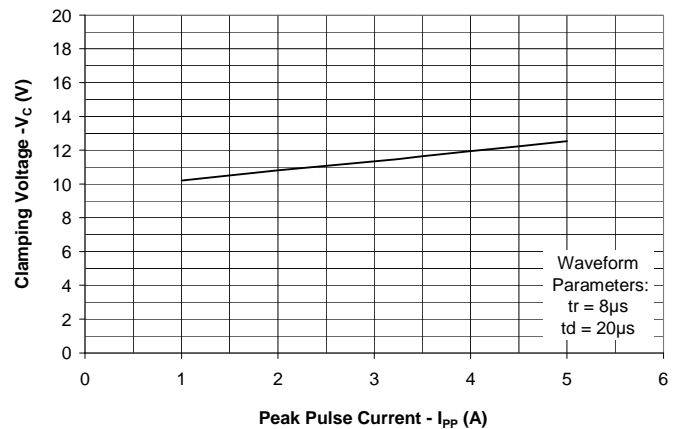
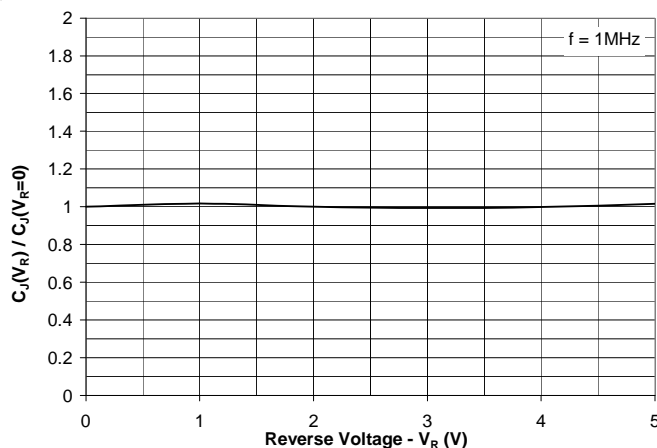
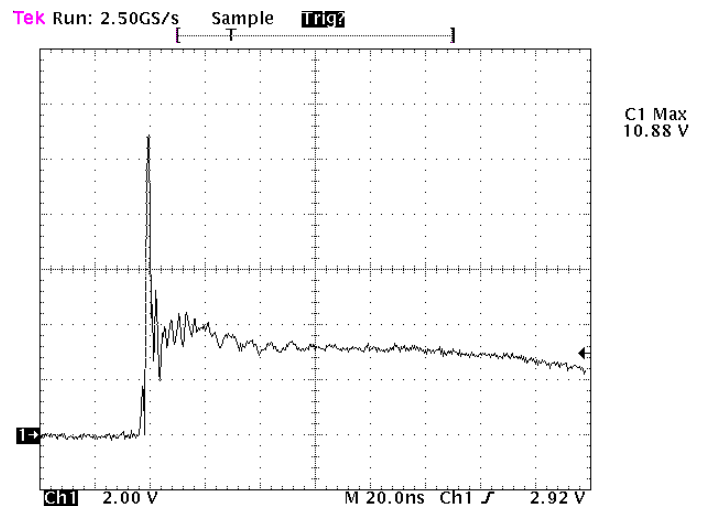


PROTECTION PRODUCTS
Absolute Maximum Rating

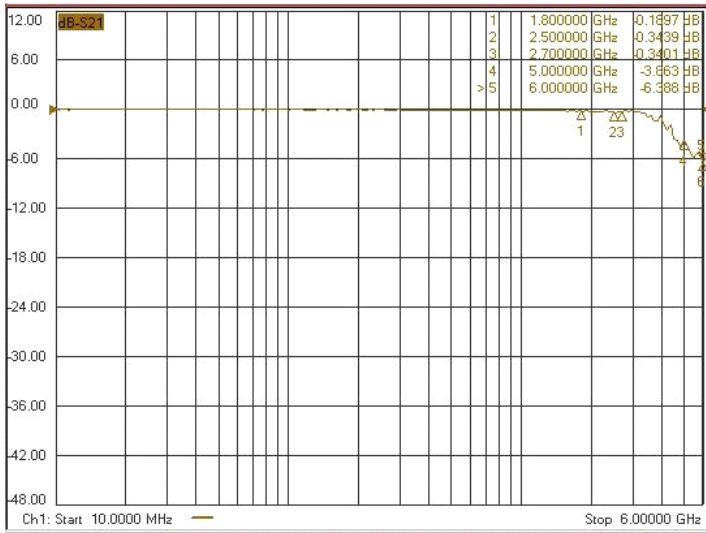
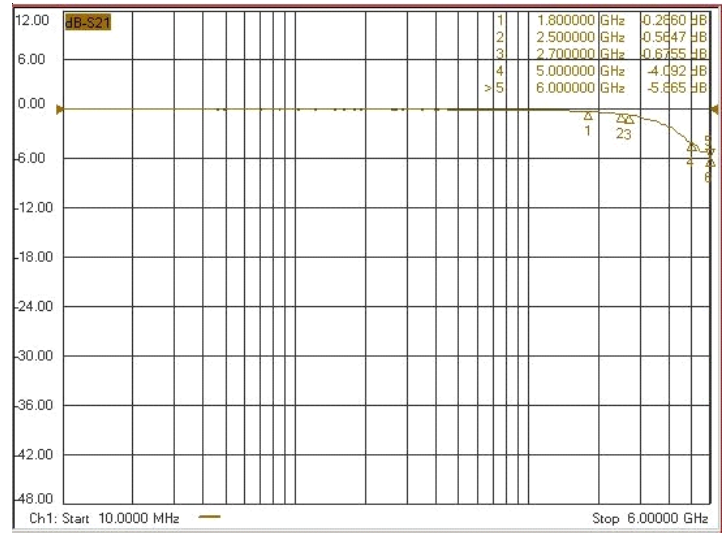
Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P _{pk}	75	Watts
Peak Pulse Current (tp = 8/20μs)	I _{pp}	5	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	+/- 18 +/- 12	kV
Operating Temperature	T _J	-55 to +125	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V _{RWM}	Any I/O to GND			5	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA, Any I/O to GND	6.5	8	11	V
Reverse Leakage Current	I _R	V _{RWM} = 5.0V, Any I/O to GND		0.005	0.100	μA
Clamping Voltage	V _C	I _{pp} = 1A, tp = 8/20μs Any I/O to GND			12	V
Clamping Voltage	V _C	I _{pp} = 5A, tp = 8/20μs Any I/O to GND			15	V
Junction Capacitance	C _J	V _R = 0V, f = 1MHz, Any I/O to GND		0.45	0.60	pF
		V _R = 0V, f = 1MHz, Between I/O pins		0.25	0.4	pF

PROTECTION PRODUCTS
Typical Characteristics
Non-Repetitive Peak Pulse Power vs. Pulse Time

Power Derating Curve

Pulse Waveform

**Clamping Voltage vs. Peak Pulse Current
(Between any I/O and Ground)**

Normalized Capacitance vs. Reverse Voltage

**ESD Clamping (Pin 1, 2, 3, or 4 to GND)
(+8kV Contact per IEC 61000-4-2)**


Note: Data is taken with a 10x attenuator

PROTECTION PRODUCTS
Typical Characteristics (Con't)
Insertion Loss S21 - I/O to I/O

Insertion Loss S21 - I/O to GND


PROTECTION PRODUCTS

Applications Information

Design Recommendations for HDMI Protection

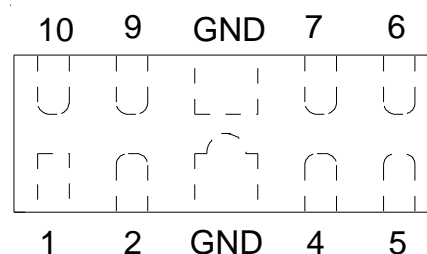
Adding external ESD protection to HDMI ports can be challenging. First, ESD protection devices have an inherent junction capacitance. Furthermore, adding even a small amount of capacitance will cause the impedance of the differential pair to drop. Second, large packages and land pattern requirements cause discontinuities that adversely affect signal integrity. The RClamp0584J is specifically designed for protection of high-speed interfaces such as HDMI. They present <0.3pF capacitance between the pairs while being rated to handle >±8kV ESD contact discharges (>±15kV air discharge) as outlined in IEC 61000-4-2. Each device is in a leadless SLP package that is less than 1.1mm wide. They are designed such that the traces flow straight through the device. The narrow package and flow-through design reduces discontinuities and minimizes impact on signal integrity. This becomes even more critical as signal speeds increase.

Pin Configuration

Figure 1 is an example of how to route the high speed differential traces through the RClamp0584J. The PCB traces are used to connect the pin pairs for each line (pin 1 to pin 10, pin 2 to pin 9, pin 4 to pin 7, pin 5 to pin 6). For example, line 1 enters at pin 1 and exits at Pin 10 and the PCB trace connects pin 1 and 10 together. This is true for lines connected at pins 2, 4, and 5 also. Ground is connected at pins 3 and 8. One large ground pad should be used in lieu of two separate pads.

TDR Measurements for HDMI

The combination of low capacitance, small package, and flow-through design means it is possible to use these devices to meet the HDMI impedance requirements of 100 Ohms ±15% without any PCB board modification. Figure 3 shows a typical impedance test result for a TDR risetime of 200ps using a Semtech evaluation board with 100 Ohm traces throughout. Measurements were taken using a TDR method as outlined in the HDMI Compliance Test Specification (CTS). As shown, the device meets the HDMI CTS requirement of 100 Ohm ±15% with plenty of margin.



Pin	Identification
1, 2, 4, 5	Input Lines
6, 7, 9, 10	Output Lines (No Internal Connection)
3, 8	Ground

Figure 1 - SLP2710P8 Pin Configuration (Top View)

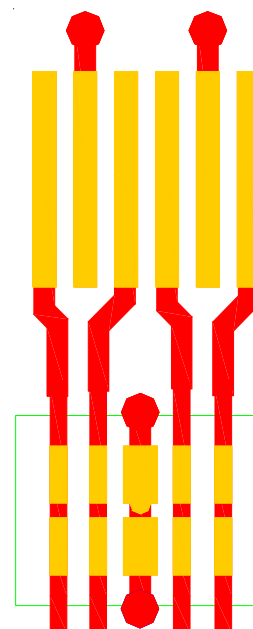


Figure 2 - Flow through Layout Using RClamp0584J

PROTECTION PRODUCTS

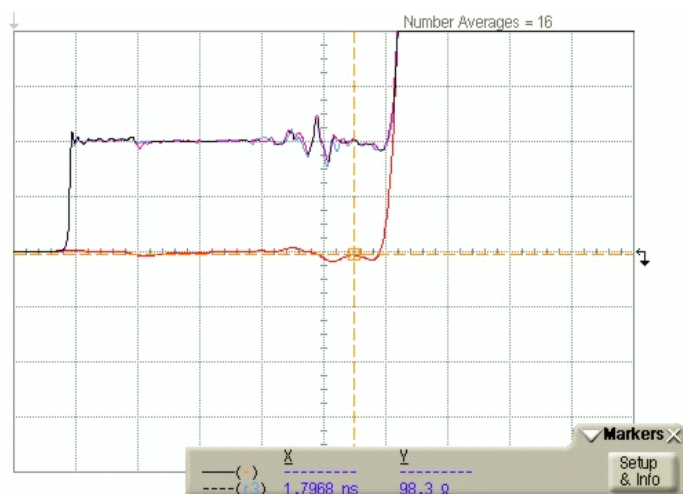
Applications Information

Figure 3 shows a typical HDMI 1.3 eye pattern at 1080p resolution. As shown there are no violations of the eye pattern with RClamp0584J in the circuit. The RClamp0506T can be used to protect the remaining lines (I2C, CEC, hot plug, etc.).

Layout Guidelines for Optimum ESD Protection

Good circuit board layout is critical not only for signal integrity, but also for effective suppression of ESD induced transients. For optimum ESD protection, the following guidelines are recommended:

- Place the device as close to the connector as possible. This practice restricts ESD coupling into adjacent traces and reduces parasitic inductance.
- The ESD transient return path to ground should be kept as short as possible. Whenever possible, use multiple micro vias connected directly from the device ground pad to the ground plane.
- Avoid running critical signals near board edges.



X-axis	1.79	(nsec)
Y-axis	98.3	(Ohm)

Figure 2 - TDR Measurement with 200ps risetime using Semtech Evaluation Board

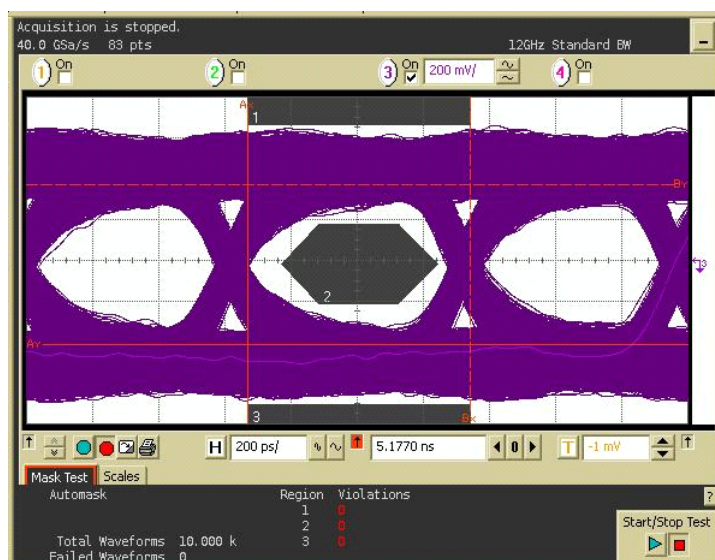
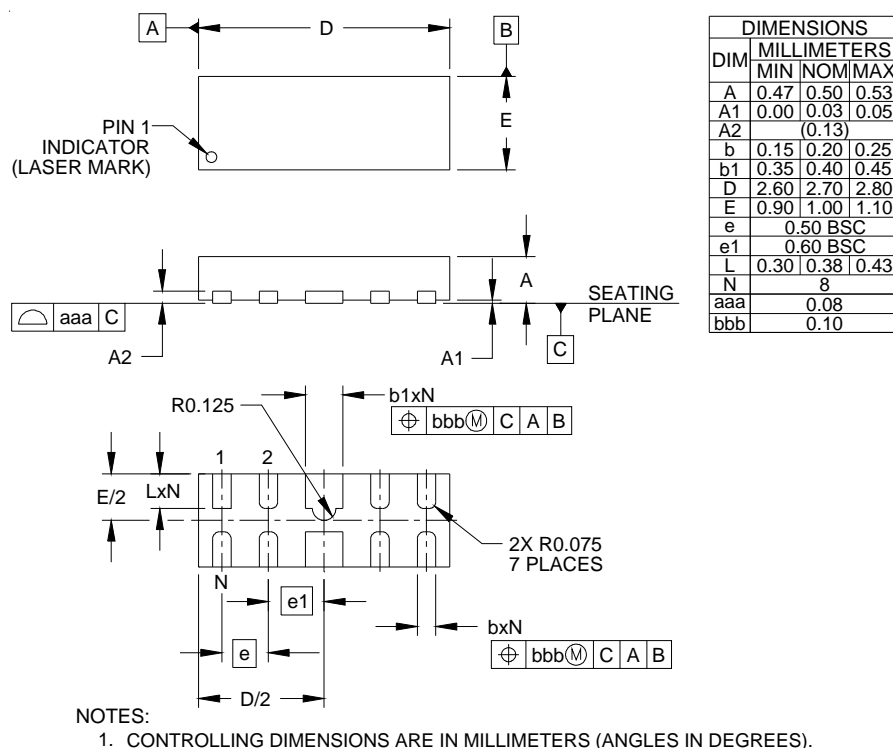
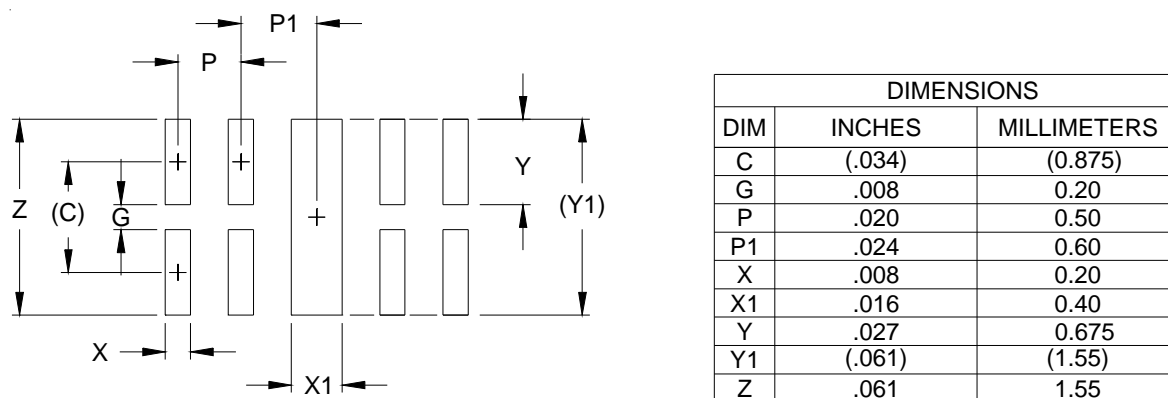
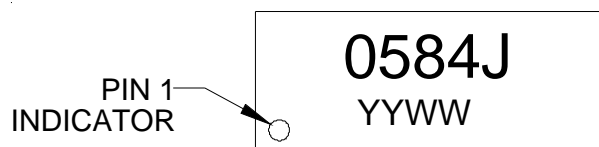


Figure 3 - Typical HDMI 1.3 Eye Pattern (1080p) with RClamp0584J

PROTECTION PRODUCTS
Outline Drawing - SLP2710P8

Land Pattern - SLP2710P8


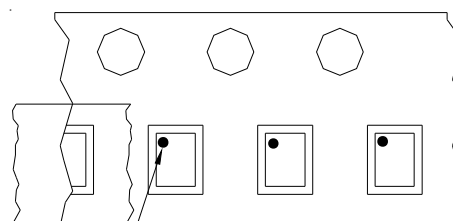
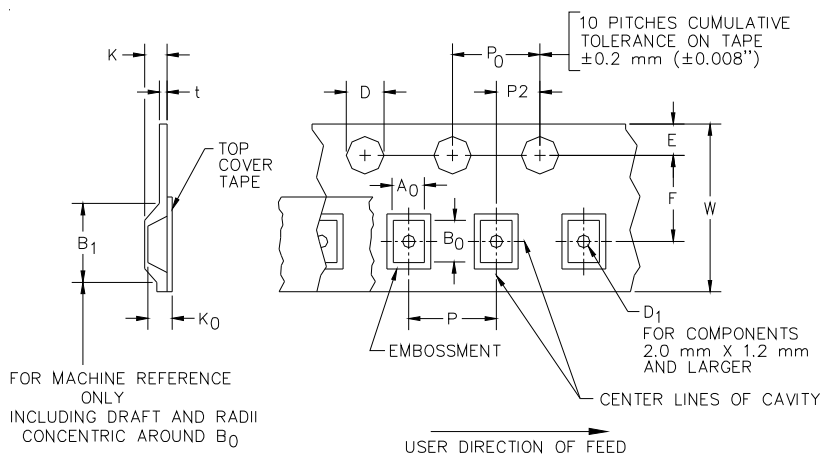
PROTECTION PRODUCTS
Marking Codes


YYWW = Date Code

Ordering Information

Part Number	Number of Lines	Qty per Reel	Reel Size
RClamp0584J.TCT	4	3000	7 Inch

RailClamp and RClamp are trademarks of Semtech Corporation.

Tape and Reel Specification


Pin 1 Location

→
User Direction of feed

Device Orientation in Tape

Part Number	A0	B0	K0
RClamp0584J	1.21 $\pm 0.10 \text{ mm}$	2.91 $\pm 0.10 \text{ mm}$	0.66 $\pm 0.10 \text{ mm}$

Tape Width	B, (Max)	D	D1	E	F	K (MAX)	P	P0	P2	T(MAX)	W
8 mm	4.2 mm	1.5 + 0.1 mm - 0.0 mm)	0.5 mm ± 0.05	1.750 ± 0.10 mm	3.5 ± 0.05 mm	2.4 mm	4.0 ± 0.1 mm	4.0 ± 0.1 mm	2.0 ± 0.05 mm	0.4 mm	8.0 mm + 0.3 mm - 0.1 mm

Contact Information

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